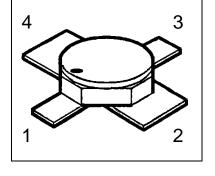


# HiRel NPN Silicon RF Transistor

- HiRel Discrete and Microwave Semiconductor
- For low noise, high-gain amplifiers up to 2GHz.
- For linear broadband amplifiers
- Hermetically sealed microwave package
- f<sub>T</sub>= 8 GHz
   F = 2.3 dB at 2 GHz
- ©esa Space Qualified

ESA/SCC Detail Spec. No.: 5611/006

Type Variant No. 06



**ESD**: Electrostatic discharge sensitive device, observe handling precautions!

| Туре        | Marking | Ordering Code | Pin ( | Pin Configuration |     | Package |          |
|-------------|---------|---------------|-------|-------------------|-----|---------|----------|
|             |         |               | 1     | 2                 | 3 4 |         |          |
| BFY193 (ql) | -       | see below     | С     | Е                 | В   | Е       | Micro-X1 |

(ql) Quality Level: P: Professional Quality

H: High Rel Quality

S: Space Quality

ES: ESA Space Quality

(see order instructions for ordering example)



|  | Maximum | Ratings |
|--|---------|---------|
|--|---------|---------|

| Parameter  | Symbol             | Values           | Unit |
|--|--------------------|------------------|------|
| Collector-emitter voltage                                  | $V_{CEO}$          | 12               | V    |
| Collector-emitter voltage, V <sub>BE</sub> =0              | V <sub>CES</sub>   | 20               | V    |
| Collector-base voltage                                     | $V_{CBO}$          | 20               | V    |
| Emitter-base voltage                                       | $V_{EBO}$          | 2                | V    |
| Collector current  | I <sub>C</sub>     | 80               | mA   |
| Base current   | I <sub>B</sub>     | 10 <sup>1)</sup> | mA   |
| Total power dissipation,<br>$T_S \le 104^{\circ}C^{2),3)}$ | P <sub>tot</sub>   | 580              | mW   |
| Junction temperature                                       | Tj                 | 200              | °C   |
| Operating temperature range                                | T <sub>op</sub>    | -65+200          | °C   |
| Storage temperature range                                  | T <sub>stg</sub>   | -65+200          | °C   |
| Thermal Resistance   | <u> </u>           |                  |      |
| Junction-soldering point 3)                                | R <sub>th JS</sub> | < 165            | K/W  |

## Notes.:

- 1) The maximum permissible base current for V<sub>FBE</sub> measurements is 30mA (spotmeasurement duration < 1s)
- 2) At T<sub>S</sub> = + 104 °C. For T<sub>S</sub> > + 104 °C derating is required.
   3) T<sub>S</sub> is measured on the collector lead at the soldering point to the pcb.

## **Electrical Characteristics**

at T<sub>A</sub>=25°C; unless otherwise specified

| Parameter                                      | Symbol           | Values |      | Unit |    |
|--|------------------|--------|------|------|----|
|  |                  | min.   | typ. | max. |    |
| DC Characteristics                             |                  |        |      |      |    |
| Collector-base cutoff current                  | I <sub>CBO</sub> | -      | -    | 100  | μA |
| $V_{CB} = 20 \text{ V}, I_{E} = 0$             |                  |        |      |      |    |
| Collector-emitter cutoff current               | I <sub>CEX</sub> | -      | -    | 600  | μA |
| $V_{CE} = 12 \text{ V}, I_B = 0.5 \mu A^{-1.}$ |                  |        |      |      |    |
| Collector-base cutoff current                  | I <sub>CBO</sub> | -      | -    | 50   | nA |
| $V_{CB} = 10 \text{ V}, I_{E} = 0$             |                  |        |      |      |    |
| Emitter base cuttoff current                   | I <sub>EBO</sub> | -      | -    | 25   | μΑ |
| $V_{EB} = 2 \text{ V}, I_{C} = 0$              |                  |        |      |      |    |
| Emitter base cuttoff current                   | I <sub>EBO</sub> | -      | -    | 0.5  | μΑ |
| $V_{EB} = 1 \text{ V}, I_{C} = 0$              |                  |        |      |      |    |

## Notes:

1.) This Test assures V(BR)CE0 > 12V



# **Electrical Characteristics** (continued)

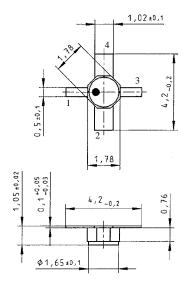
| Parameter   | Symbol                   |      | Values | 3    | Unit |
|---|--------------------------|------|--------|------|------|
|   |                          | min. | typ.   | max. |      |
| DC Characteristics  |                          |      |        | •    |      |
| Base-Emitter forward voltage  | $V_{FBE}$                | -    | -      | 1    | V    |
| $I_E = 30 \text{ mA}, I_C = 0$                                      |                          |      |        |      |      |
| DC current gain   | h <sub>FE</sub>          | 50   | 100    | 175  | -    |
| $I_C = 30$ mA, $V_{CE} = 8$ V                                       |                          |      |        |      |      |
| AC Characteristics  |                          |      |        |      |      |
| Transition frequency  | f <sub>T</sub>           |      |        |      | GHz  |
| $I_C = 40 \text{mA}, \ V_{CE} = 5 \ V, \ f = 500 \ \text{MHz}$      |                          | 6,5  | 7.5    | -    |      |
| $I_C = 50 \text{ mA}, V_{CE} = 8 \text{ V}, f = 500 \text{ MHz}$    |                          | -    | 8      | -    |      |
| Collector-base capacitance  | ССВ                      | -    | 0.56   | 0.75 | pF   |
| $V_{CB} = 10 \text{ V}, V_{BE} = \text{vbe} = 0, f = 1 \text{ MHz}$ |                          |      |        |      |      |
| Collector-emitter capacitance                                       | C <sub>CE</sub>          | -    | 0.34   | -    | pF   |
| $V_{CE} = 10 \text{ V}, V_{BE} = \text{vbe} = 0, f = 1 \text{ MHz}$ |                          |      |        |      |      |
| Emitter-base capacitance  | C <sub>EB</sub>          | -    | 1.9    | 2.4  | pF   |
| $V_{EB} = 0.5V$ , $V_{CB} = vcb = 0$ , $f = 1 MHz$                  |                          |      |        |      |      |
| Noise Figure  | F                        | -    | 2.3    | 2.9  | dB   |
| $I_C = 15 \text{ mA}, V_{CE} = 5 \text{ V}, f = 2 \text{ GHz},$     |                          |      |        |      |      |
| $Z_S = Z_{Sopt}$  |                          |      |        |      |      |
| Power gain  | Gma 1.)                  | 12.5 | 13.5   | -    | dB   |
| $I_C = 40$ mA, $V_{CE} = 5V$ , $f = 2$ GHz                          |                          |      |        |      |      |
| $Z_S = Z_{Sopt}$ , $Z_L = Z_{Lopt}$                                 |                          |      |        |      |      |
| Transducer gain   | $\left S_{21e}\right ^2$ | 8    | 9      | -    | dB   |
| $I_C = 40$ mA, $V_{CE} = 5$ V, $f = 2$ GHz                          |                          |      |        |      |      |
| $Z_S = Z_L = 50 \Omega$   |                          |      |        |      |      |
| Output Power  | P <sub>OUT</sub>         | 16.5 | 17.5   | -    | dBm  |
| $I_C = 50$ mA, $V_{CE} = 5$ V, $f = 2$ GHz,                         |                          |      |        |      |      |
| $P_{IN}$ =10dBm, $Z_S = Z_L = 50 \Omega$                            |                          |      |        |      |      |

Notes.:

1.) 
$$G_{ma} = \left| \frac{S21}{S12} \right| (k - \sqrt{k^2 - 1}), \quad G_{ms} = \left| \frac{S21}{S12} \right|$$



# Micro-X1 Package



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